



Generic photo used for illustration purposes only

CASE STYLE: FV1206

Maximum Ratings

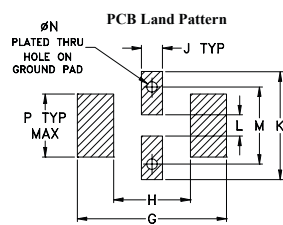
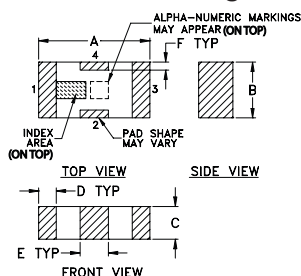
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
RF Power Input*	8.5W max. at 25°C

* Passband rating, derate linearly to 3.5W at 100°C ambient.
Permanent damage may occur if any of these limits are exceeded.

Pin Connections

RF IN	1
RF OUT	3
GROUND	2,4

Outline Drawing



Suggested Layout,
Tolerance to be within ±.002

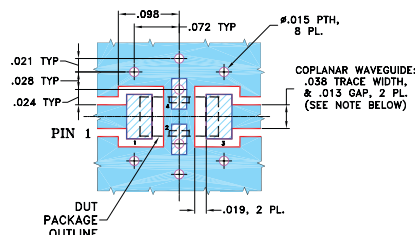
Outline Dimensions (inch/mm)

A	B	C	D	E	F	G
.126	.063	.037	.020	.032	.009	.169
3.20	1.60	0.94	0.51	0.81	0.23	4.29

H	J	K	L	M	N	P	wt
.087	.024	.122	.024	.087	.012	.071	grams
2.21	0.61	3.10	0.61	2.21	0.30	1.80	.020

Demo Board MCL P/N: TB-270

Suggested PCB Layout (PL-137)



- NOTES: 1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH THICKNESS .020" ± .0015". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 - DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Features

- excellent power handling, 8.5W
- small size
- 7 sections
- temperature stable
- LTCC construction
- protected by U.S. Patent 6,943,646

Applications

- harmonic rejection
- VHF/UHF transmitters/receivers

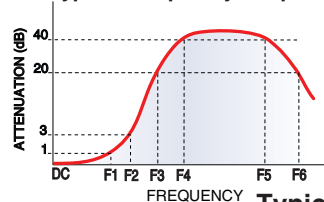
Electrical Specifications^(1,2) at 25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Insertion Loss	DC-F1	DC-530	—	—	1.2	dB
	Freq. Cut-Off	F2	700	—	3.0	—	dB
	VSWR	DC-F1	DC-530	—	1.2	—	:1
Stop Band	Rejection Loss	F3	820	20	—	—	dB
		F4-F5	945-3000	—	40	—	dB
		F6	6000	—	20	—	dB
	VSWR	F3-F6	820-6000	—	20	—	:1

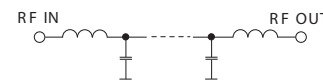
(1) In Applications where DC isolation to ground is required, coupling capacitors are recommended to avoid DC leakage. Alternatively, if DC pass IN-OUT is required, Mini-Circuits' "D" suffix version of this model will support DC IN-OUT, and provide >100 MOhm isolation to ground.

(2) Measured on Mini-Circuits Characterization Test Board TB-270.

Typical Frequency Response

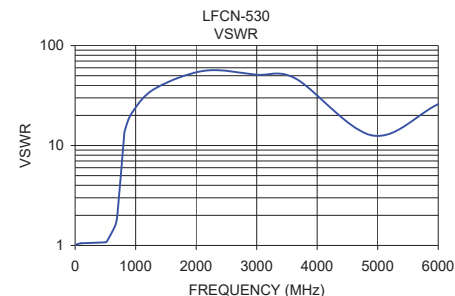
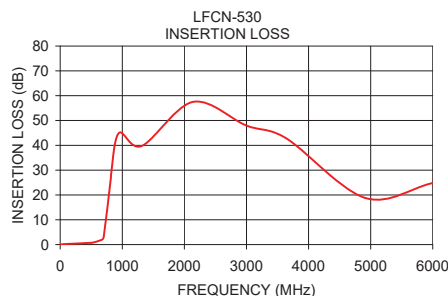


Electrical Schematic



Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
1.00	0.05	1.01
100.00	0.22	1.05
500.00	0.73	1.07
530.00	0.81	1.11
670.00	1.95	1.62
700.00	2.89	2.08
815.00	26.41	13.60
820.00	28.41	14.03
945.00	44.98	21.46
1315.00	39.77	36.97
2140.00	57.51	56.04
3000.00	47.94	51.10
3640.00	42.84	46.96
4910.00	18.81	12.61
6000.00	24.80	25.94



Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Ceramic Low Pass Filter

LFCN-530D

Typical Performance Data

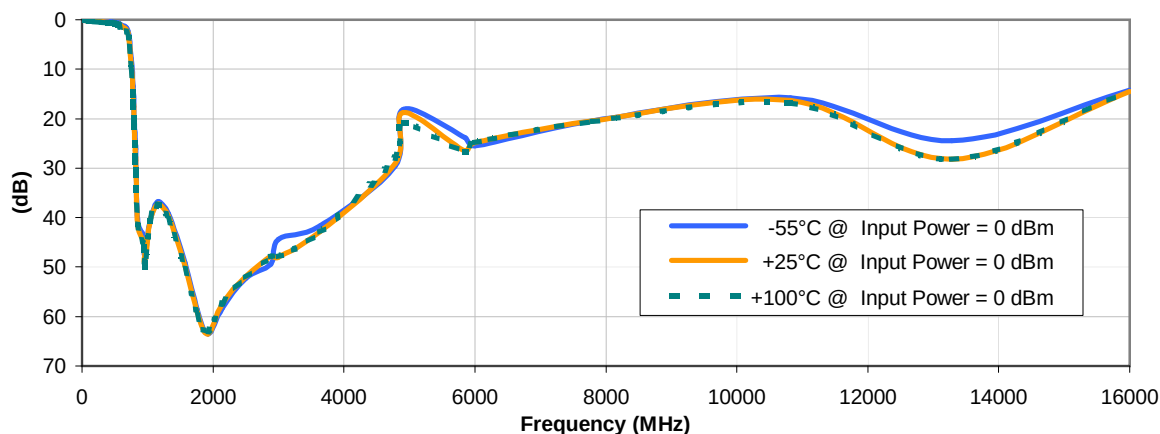
FREQ. (MHz)	INSERTION LOSS (dB)			INPUT RETURN LOSS (dB)			OUTPUT RETURNLOSS (dB)		
	@ -55° C	@ +25° C	@ +100° C	@ -55° C	@ +25° C	@ +100° C	@ -55° C	@ +25° C	@ +100° C
1	0.02	0.05	0.07	47.11	46.06	45.60	47.00	46.06	45.40
50	0.12	0.16	0.18	33.82	32.31	31.64	33.20	31.72	31.06
100	0.17	0.22	0.24	32.97	31.93	31.57	31.11	30.04	29.57
200	0.25	0.32	0.35	32.50	34.75	37.04	27.52	27.62	27.74
300	0.33	0.41	0.47	33.65	39.11	51.62	26.29	26.33	26.27
400	0.43	0.54	0.62	33.23	35.64	37.40	26.90	26.79	26.60
500	0.58	0.73	0.84	28.58	28.88	28.88	26.68	26.53	26.24
515	0.61	0.77	0.89	27.16	27.21	27.01	25.83	25.60	25.23
530	0.65	0.81	0.94	25.67	25.53	25.20	24.74	24.44	24.02
545	0.69	0.87	1.00	24.13	23.86	23.45	23.60	23.24	22.79
570	0.78	0.97	1.12	21.67	21.25	20.78	21.64	21.23	20.78
670	1.57	1.95	2.27	13.04	12.49	12.01	16.55	16.79	16.98
700	2.33	2.89	3.38	9.68	9.12	8.65	13.76	13.97	14.05
725	3.81	4.69	5.46	6.26	5.85	5.52	9.15	9.10	8.97
755	7.84	9.23	10.41	3.03	2.95	2.89	4.60	4.70	4.73
780	13.42	15.14	16.58	1.74	1.85	1.92	2.76	2.99	3.13
795	17.61	19.49	21.09	1.38	1.52	1.62	2.21	2.47	2.63
815	24.24	26.41	28.26	1.12	1.28	1.40	1.80	2.06	2.23
820	26.15	28.41	30.32	1.07	1.24	1.36	1.73	1.99	2.16
850	40.89	41.61	41.38	0.91	1.07	1.19	1.46	1.71	1.87
945	43.79	44.98	45.98	0.66	0.81	0.91	1.15	1.38	1.53
960	47.58	49.04	49.97	0.64	0.78	0.89	1.13	1.35	1.50
1050	40.25	40.20	40.18	0.53	0.66	0.76	1.00	1.20	1.35
1165	36.81	37.20	37.50	0.44	0.56	0.66	0.86	1.04	1.18
1315	39.26	39.77	40.21	0.35	0.47	0.56	0.68	0.85	0.97
1570	49.21	49.82	50.39	0.27	0.38	0.48	0.47	0.61	0.71
1755	58.61	59.17	59.60	0.23	0.35	0.44	0.38	0.50	0.59
1925	63.57	63.50	63.03	0.20	0.32	0.41	0.31	0.43	0.50
2140	58.41	57.51	57.31	0.19	0.31	0.40	0.26	0.36	0.43
2500	52.23	51.92	52.20	0.20	0.32	0.40	0.18	0.29	0.35
2880	49.46	47.84	47.83	0.24	0.35	0.43	0.20	0.30	0.36
3000	44.44	47.94	47.84	0.24	0.34	0.42	0.21	0.29	0.35
3640	41.72	42.84	42.96	0.23	0.37	0.46	0.21	0.30	0.38
4780	29.67	29.13	27.98	0.50	0.71	0.93	0.32	0.49	0.66
4910	18.10	18.81	21.01	1.63	1.38	1.09	1.00	0.91	0.79
5840	23.86	26.47	26.66	0.66	0.73	0.86	1.08	0.88	0.84
6000	25.48	24.80	24.78	0.44	0.67	0.84	0.35	0.54	0.70
7800	20.42	20.46	20.60	0.48	0.76	0.95	0.33	0.56	0.72
10820	15.77	16.32	16.76	1.90	2.44	2.99	0.73	1.12	1.49
13280	24.50	28.15	28.24	1.70	2.04	2.47	1.90	1.85	2.02
16000	14.26	14.50	14.44	2.93	3.48	4.22	3.38	3.68	3.77

Ceramic Low Pass Filter

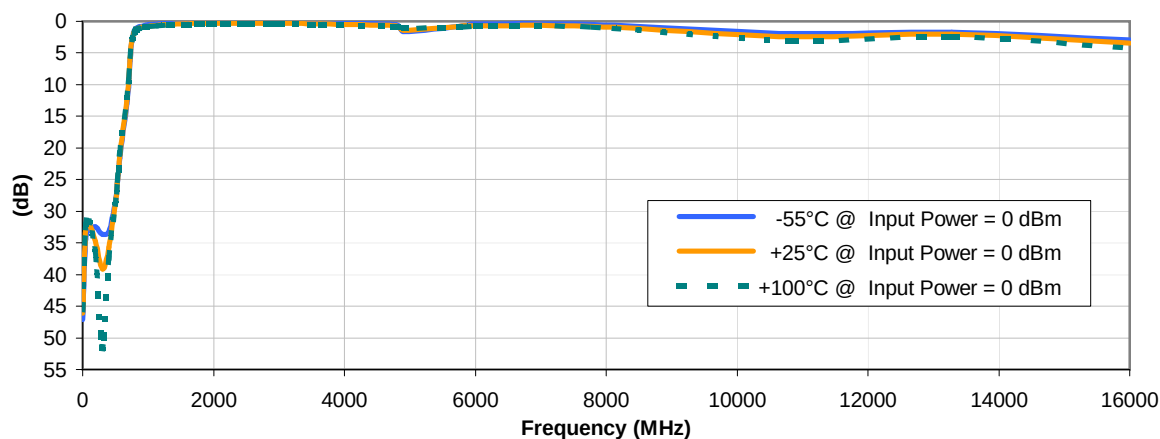
Typical Performance Curves

LFCN-530D

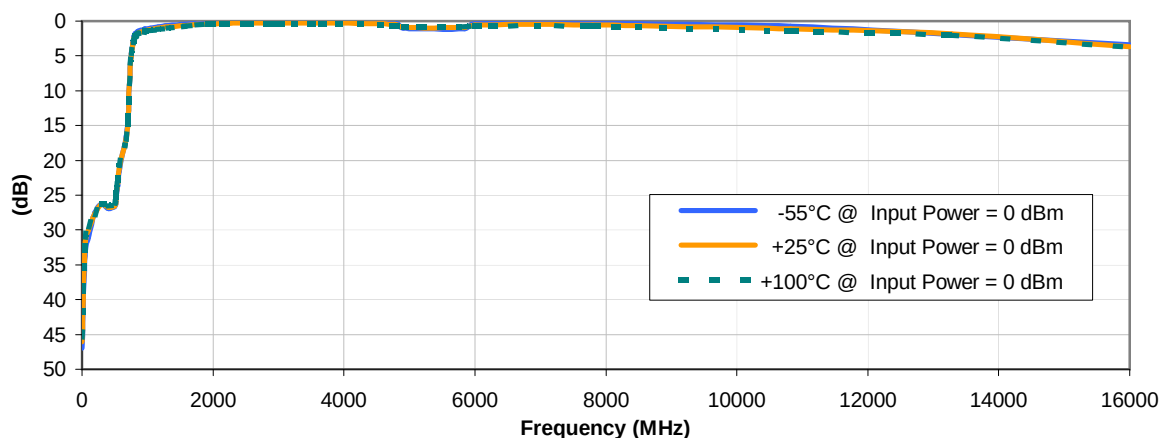
INSERTION LOSS vs. TEMPERATURE



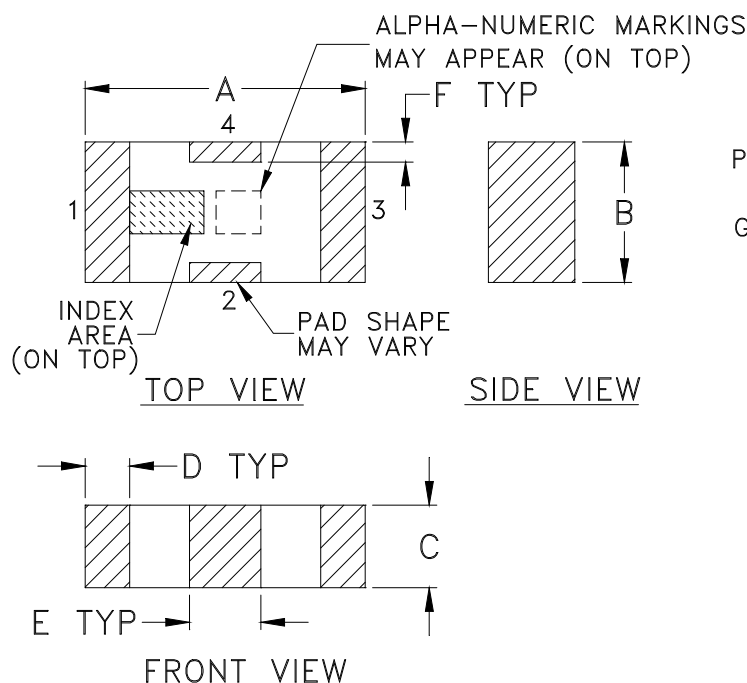
INPUT RETURN LOSS vs. TEMPERATURE



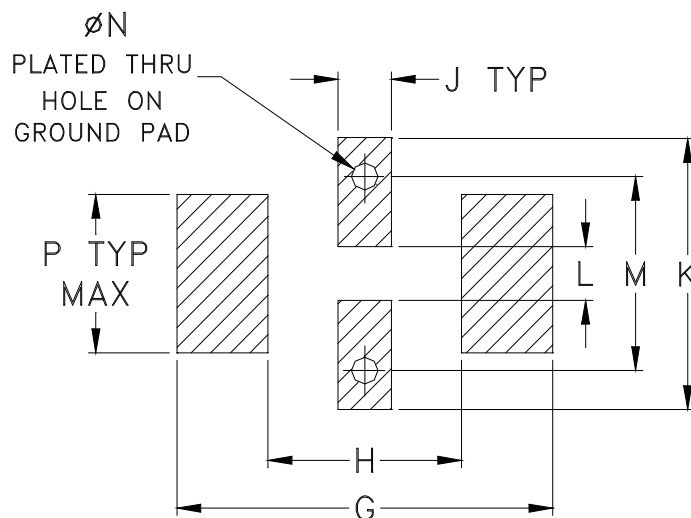
OUTPUT RETURN LOSS vs. TEMPERATURE



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	WT. GRAM
FV1206	.126 (3.20)	.063 (1.60)	.037 (0.94)	.020 (0.51)	.032 (0.81)	.009 (0.23)	.169 (4.29)	.087 (2.21)	.024 (0.61)	.122 (3.10)	.024 (0.61)	.087 (2.21)	.012 (0.30)	.071 (1.80)	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F71

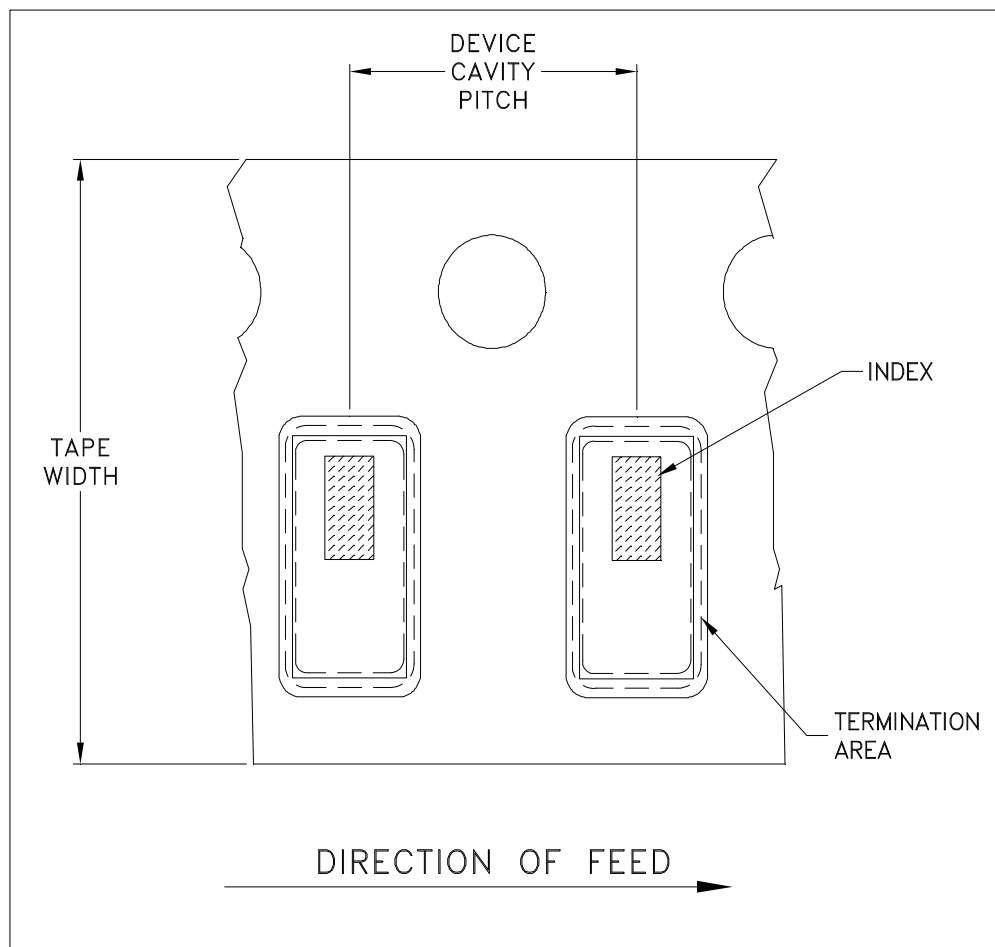


ILLUSTRATION 1

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



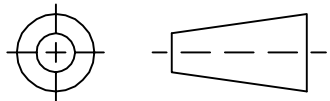
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RF/IF MICROWAVE COMPONENTS

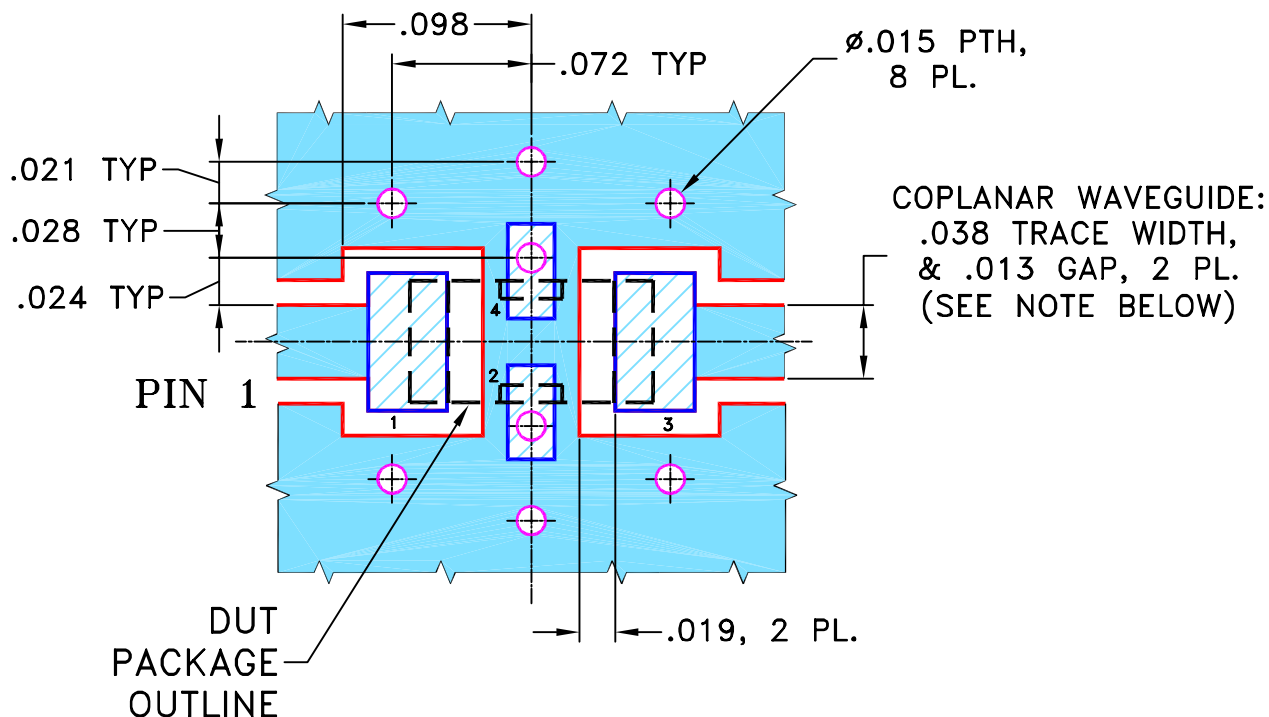
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M88634	NEW RELEASE	08/28/03	GF	ABD
A	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL

**SUGGESTED MOUNTING CONFIGURATION
FOR FV1206 CASE STYLE, "nx" PIN CONNECTION**

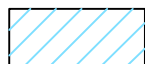


NOTES: 1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH THICKNESS .020" $\pm$.0015".
COPPER: 1/2 OZ. EACH SIDE.
FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC
(SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

GF

08/27/03

CHECKED

AV

08/28/03

APPROVED

ABD

08/28/03



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, nx, FV1206, LFCN/HFCN, TB-270

SIZE

A

CODE IDENT

15542

DRAWING NO:

98-PL-137

REV:

A

FILE:

98PL137

SCALE:

10:1

SHEET:

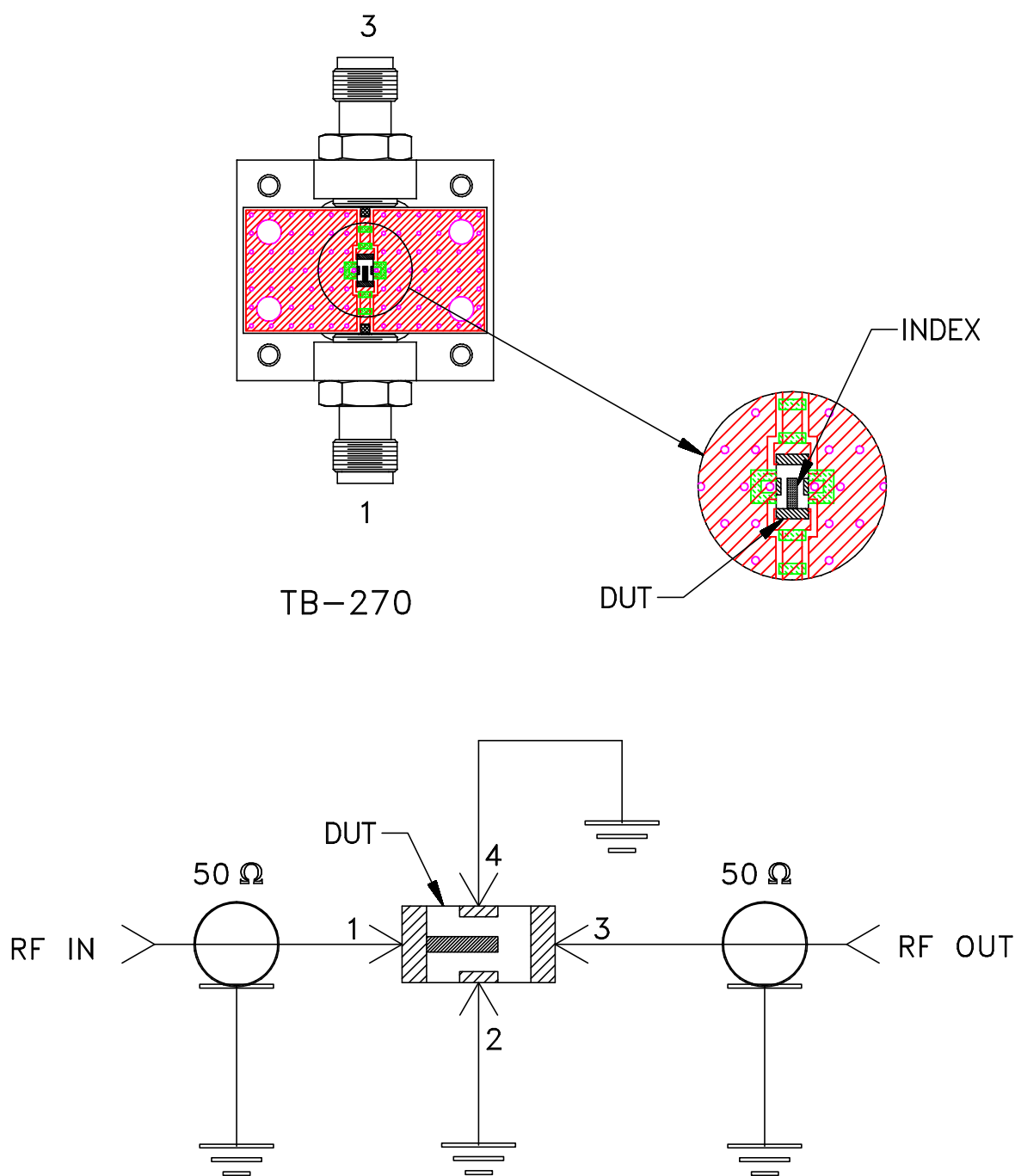
1 OF 1

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ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: ROGERS RO4350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A